

# DFCH31G84HDJAA

## Part Number/Tape & Reel information

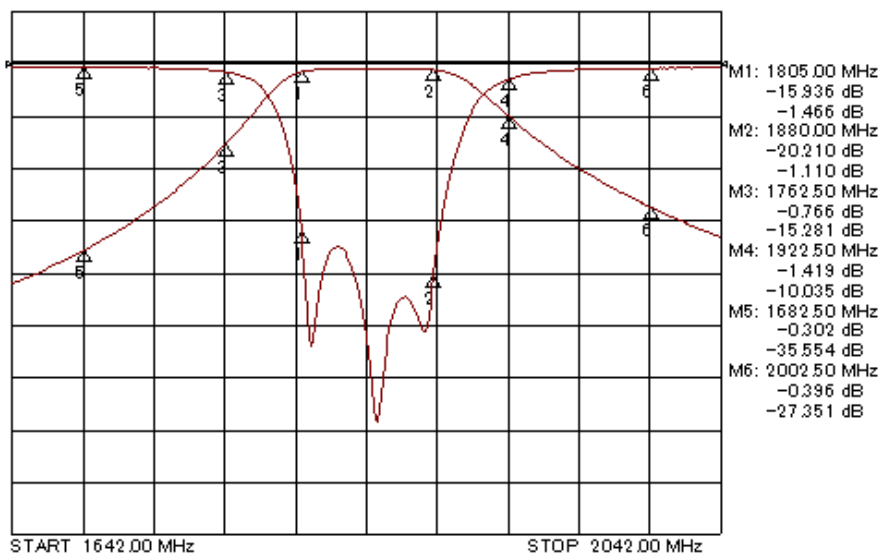
| Part Number        | Packaging        | MOQ           |
|--------------------|------------------|---------------|
| DFCH31G84HDJAA-RD1 | 330 mm dia. reel | 1000 pcs/reel |

## Specifications -35 to +85°C

| Parameter                     | IN→OUT  |
|-------------------------------|---|
| Center Frequency              | F0 : 1842.5 MHz   |
| Band Width (BW)               | F0 ± 37.5 MHz   |
| Insertion Loss                | 2.0 dB max.   |
| Ripple at BW                  | 0.8 dB max.   |
| V.S.W.R. at BW                | 2.0 max.  |
| Input Power                   | 1.0 W max.  |
| Attenuation<br>Absolute value | F0±80MHz 8 dB min.<br>F0-160MHz 30 dB min.<br>F0+160MHz 26 dB min.<br>F0±350MHz 30 dB min |
| Characteristic Impedance      | 50Ω   |

## Frequency Response

S11 logMAG 5dB/REF0dB  
S21 logMAG 10dB/REF0dB

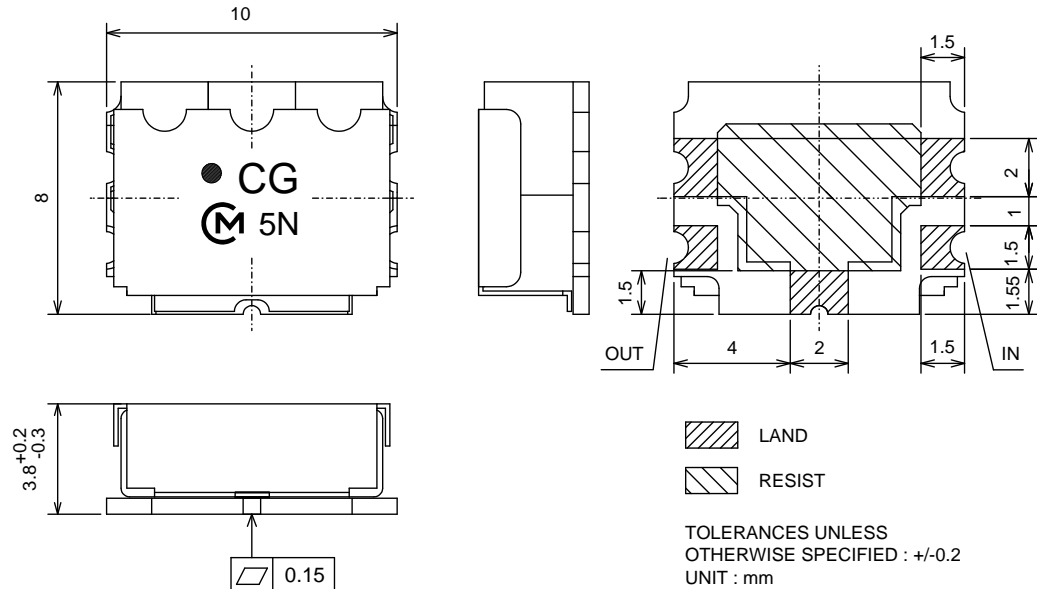


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\*Note: All the technical data and information contained herein are subject to change without advanced notice.

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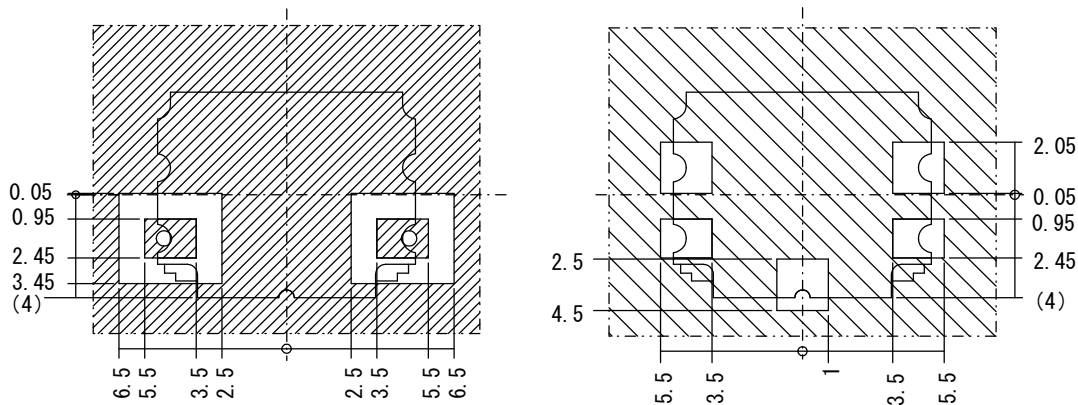
### Dimensions and Marking



NOTE : Construction of Number

LOT NO : 5N      5 : Year

N: Month (1 to 9, Oct.-O, Nov.-N, Dec.-D)

Recommend Land Pattern (reference)

Electrode

Solder Resist

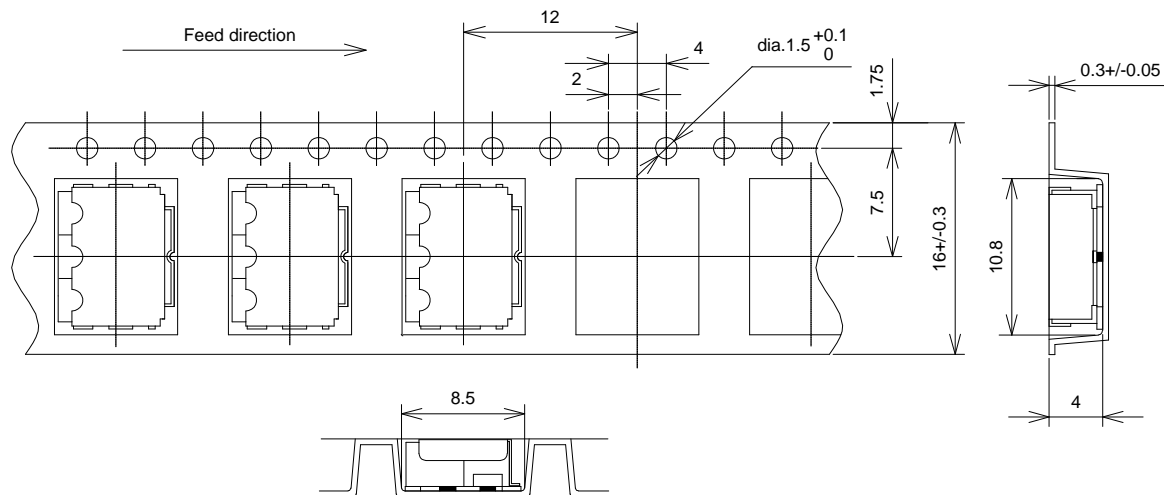
Note : Impedance of signal lines should be 50 ohms including land pattern. This standard condition is applying to the glass epoxy board (t = 1.0mm, dielectric constant = 4.8, copper plating on both surfaces) and the land patterns are connected to 50 ohms micro-strip lines on back side surface through the via hole.

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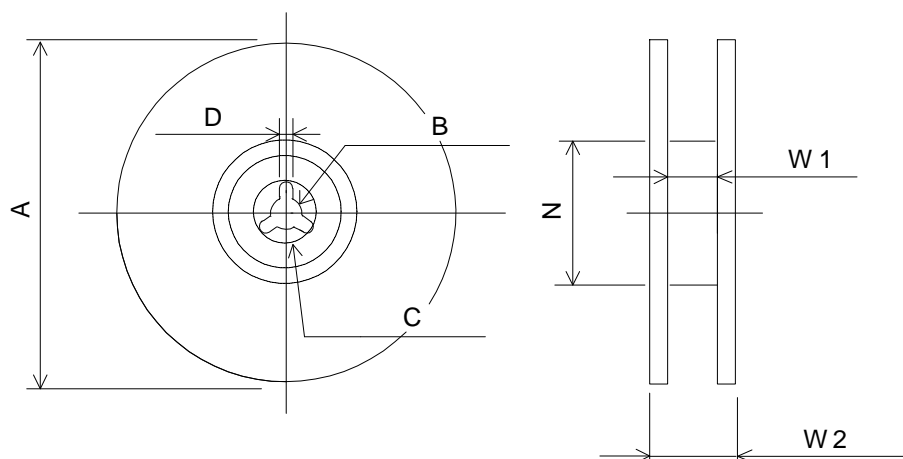
# DFCH31G84HDJAA

## Dimensions of Carrier Tape



TOLERANCES UNLESS  
 OTHERWISE SPECIFIED :  $\pm 0.1$   
 DIMENSIONS : mm

## Dimensions of Reel



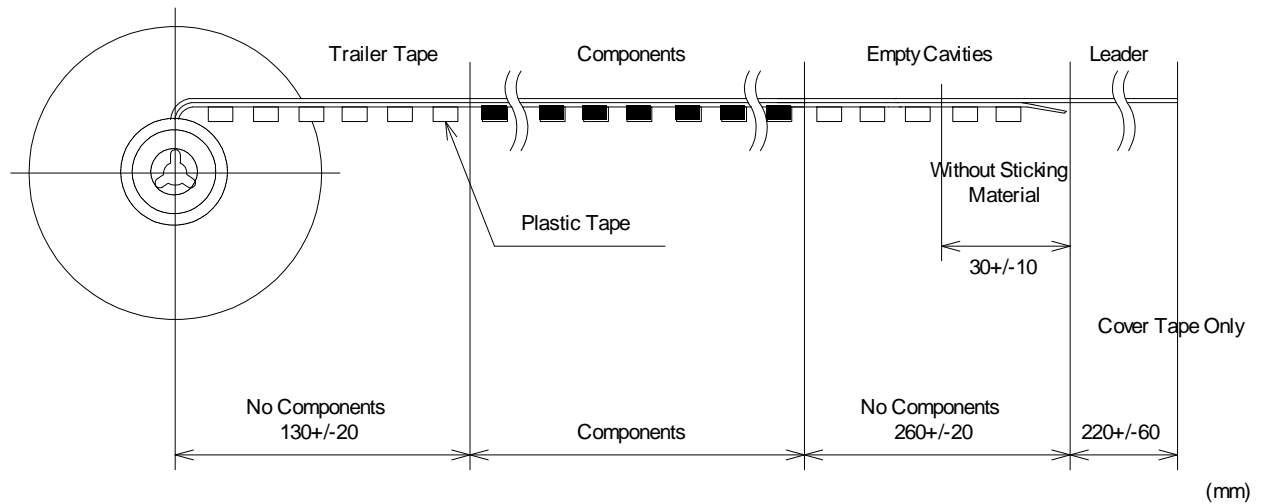
| Murata Part Number | A $\pm 2.0$ | B $\pm 0.5$ | C $\pm 0.8$ | D $\pm 0.5$ | N (min.)  | W1 $\pm 1.5$ | W2 (max.) |
|--------------------|-------------|-------------|-------------|-------------|-----------|--------------|-----------|
| DFCH31G84HDJAA-RD1 | $\phi 330$  | $\phi 13$   | $\phi 21$   | 2           | $\phi 50$ | 17.5         | 23        |

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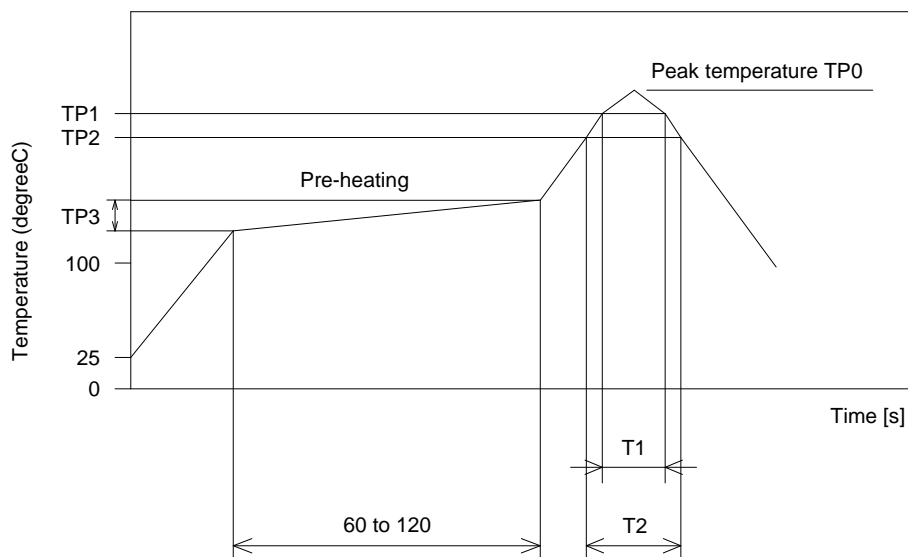
# DFCH31G84HDJAA

## Taping Condition



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## Reflow Soldering Standard Conditions

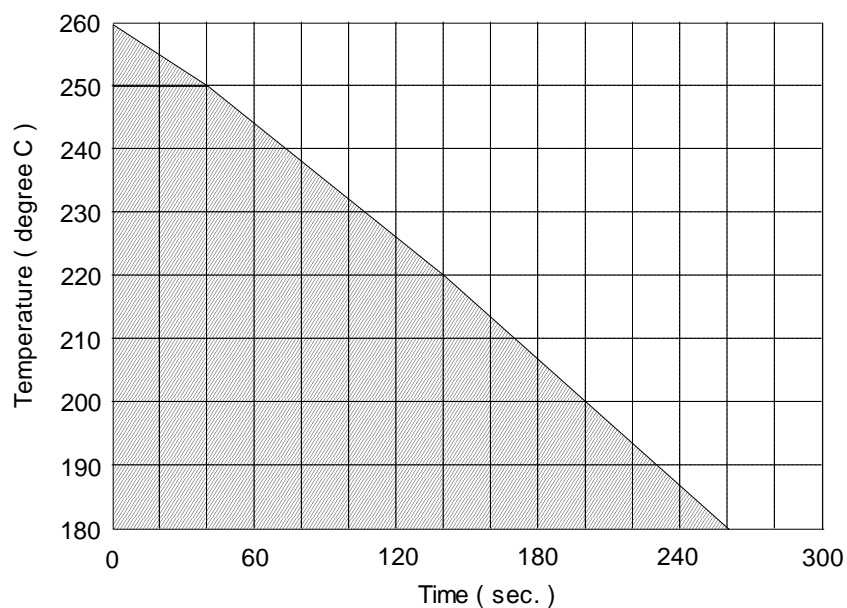


Measuring point of temperature : IN-OUT Terminals of The Device

Reflow Soldering : Both Convection and Infrared Rays, Hot Air and Hot Plate

|  |                     | TP0 (°C ) | TP1 (°C ) | T1 (s)   | TP2 (°C ) | T2 (s) | TP3 (°C )  |
|--|---------------------|-----------|-----------|----------|-----------|--------|------------|
| Reflow standard condition                | Sn-40Pb solder      | 225+/-5   | 200       | 20 to 40 | ---       | ---    | 140 to 160 |
|  | Sn-3Ag-0.5Cu solder | 245+/-5   | 220       | 30 to 60 | ---       | ---    | 150 to 180 |
| Test condition of reflow heat resistance |                     | 260+5/-0  | 240       | 20       | 220       | 70     | 150 to 180 |

## Allowable Temperature and Time of Reflow Soldering



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